

SkyMOS1 N-MOSFET 150V, $7m\Omega$, 120A

Features

- Uses CRM(CQ) advanced SkyMOS1 technology
- Extremely low on-resistance R_{DS(on)}
- Excellent Q_qxR_{DS(on)} product(FOM)
- Qualified according to JEDEC criteria

Product Summary

V_{DS}	150V
R _{DS(on)}	7mΩ
I _D	120A

Applications

- Motor control and drive
- Battery management
- UPS (Uninterrupible Power Supplies)

100% Avalanche Tested



Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRST085N15N	-	TO-220	Tube	N/A	N/A	50pcs
CRSS082N15N	-	TO-263	Tube	N/A	N/A	50pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V _{DS}	150	V
Continuous drain current			
T _C = 25°C (Silicon limit)	I_{D}	128	Α
T _C = 25°C (Package limit)	*D	120	
T _C = 100°C (Silicon limit)		81	
Pulsed drain current ($T_C = 25^{\circ}C$, t_p limited by T_{jmax})	${ m I_{D~pulse}}$	480	Α
Avalanche Current (L=0.5mH)	I _{AS}	36	А
Avalanche energy, single pulse (L=0.5mH, Rg=25 Ω)	E _{AS(Note 1)}	324	mJ
Repeative avalanche Current (L=0.5mH)	I_{AR}	16	А
Repeative avalanche (L=0.5mH)	E _{AR(Note 2)}	64	mJ
Gate-Source voltage	V_{GS}	±20	V





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Power dissipation ($T_C = 25$ °C)	P _{tot}	227	W
Operating junction and storage temperature	T_j , T_{stg}	-55+150	°C

^{*.} Notes:



^{1.}EAS is tested at starting Tj = 25° C, L = 0.5mH, IAS = 36A, VGS = 10V.

^{2.}Repetitive rating, pulse width limited by junction temperature TJ(MAX)=150°C. Ratings are based on low frequency and duty cycles to keep initial TJ=25°C.



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Thermal Resistance

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	R_{thJC}	0.52	°C/W
Thermal resistance, junction – ambient(min. footprint)	R_{thJA}	60	° C/ W

Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

Davameter	Value			IIm!	Took Condition		
Parameter	Symbol	min.	typ.	max.	Unit	Test Condition	
Static Characteristic							
Drain-source breakdown voltage	BV _{DSS}	150	-	-	V	V _{GS} =0V, I _D =250uA	
Gate threshold voltage	V _{GS(th)}	2	3	4	V	$V_{DS}=V_{GS}$, $I_{D}=250$ uA	
						V _{DS} =150V,V _{GS} =0V	
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	T _j =25°C	
		-	-	10		T _j =125°C	
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=\pm20V, V_{DS}=0V$	
						$V_{GS}=10V$, $I_D=50A$	
					mΩ	T _j =25°C	
		-	7.0	8.5	11122	TO-220	
Drain-source on-state	D	-	6.8	8.2		TO-263	
resistance	$R_{DS(on)}$					$V_{GS}=10V$, $I_D=50A$	
						T _j =100°C	
		-	11.3	14.1	mΩ	TO-220	
		_	11.1	13.9		TO-263	
Transconductance	g_{fs}	-	91.8	-	S	$V_{DS}=5V,I_{D}=50A$	

Dynamic Characteristic

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Input Capacitance	C _{iss}	-	4217	6326		
Output Capacitance	C _{oss}	-	512	768	pF	V_{GS} =0V, V_{DS} =75V, f =1MHz
Reverse Transfer Capacitance	C_{rss}	-	38	57		T=IMHZ
Gate Total Charge	Q_{G}	-	63	94.5		
Gate-Source charge	Q_{gs}	-	21	31.5	nC	V_{GS} =10V, V_{DS} =75V, I_{D} =50A, f=1MHz;
Gate-Drain charge	Q_{gd}	-	15	22.5	IIC	,
Threshold Gate Charge	$Q_{g(th)}$	-	13.5	20.3		





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Turn-on delay time	t _{d(on)}	-	11	16.5	Vds=75V	
Rise time	t _r	-	107	160.5	nc	Id=100A Rg=2.7Ω
Turn-off delay time	$t_{d(off)}$	-	54	81	Vg	Vgs=10V; (Note 3,4)
Fall time	t _f	-	102	153		
Gate resistance	R_{G}	-	3.0	5.5	Ω	V_{GS} =0V, V_{DS} =0V, f =1MHz

Body Diode Characteristic

Parameter	Symbol		Value		Unit	Unit Test Condition	
	Syllibol	min.	typ.	max.	Oilit	rest condition	
Body Diode Forward Voltage	V_{SD}	-	0.86	1.4	>	V _{GS} =0V,I _{SD} =50A	
Body Diode Reverse Recovery Time	t _{rr}	-	100	200	ns	ISD=100A, VGS=0V, dIF/dt=100A/us;	
Body Diode Reverse Recovery Charge	Q_{rr}	-	451	902	nC		

^{※.} Notes

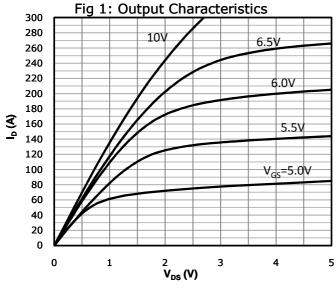


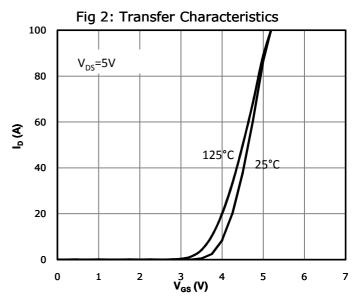
^{3.}Pulse Test : Pulse Width \leq 300us, duty cycle \leq 2%.

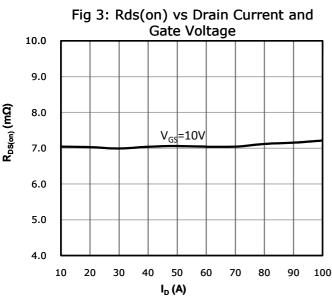
^{4.} Essentially independent of operating temperature.

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Typical Performance Characteristics







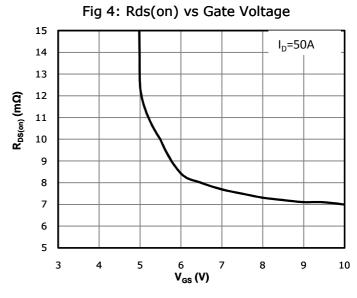


Fig 5: Rds(on) vs. Temperature 2.8 V_{GS}=10V 2.5 $I_D = 50A$ R_{DS(on)}_Normalized 2.2 1.9 1.6 1.3 1.0 0.7 0.4 25 75 125 150 175 Tj - Junction Temperature (°C)

Fig 6: Capacitance Characteristics 10000 Ciss C - Capacitance (PF) 1000 100 Crss $V_{GS}=0V$ f=1MHz 10 90 100 110 120 0 10 20 30 40 50 60 70 80 V_{DS} (V)

Fig 7: Gate Charge Characteristics

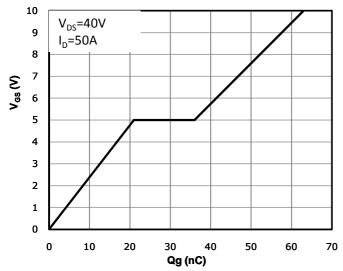
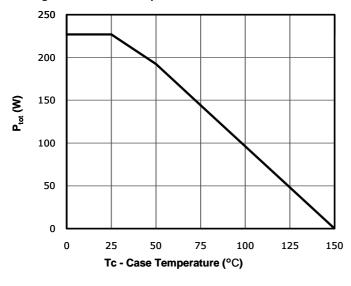


Fig 8: Body-diode Forward Characteristics 100 10 125°(1 0.1 0.01 0 0.2 0.4 0.6 0.8 1 1.2 1.4 1.6

Fig 9: Power Dissipation



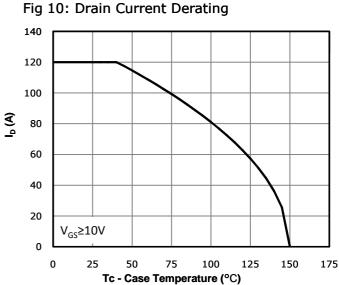


Fig 11: Safe Operating Area

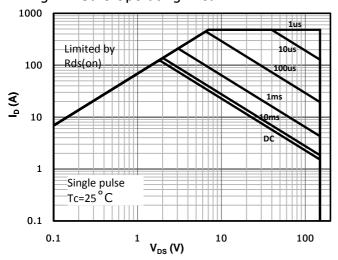
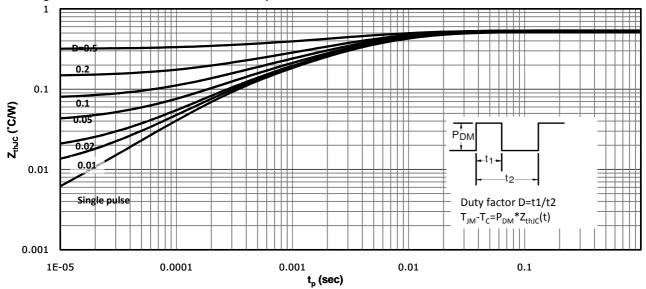




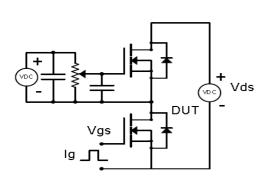
Fig 12: Max. Transient Thermal Impedance

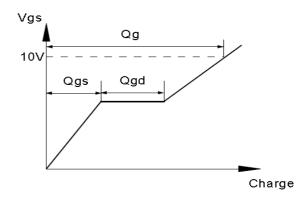




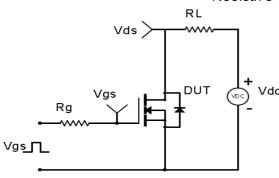
Test Circuit & Waveform

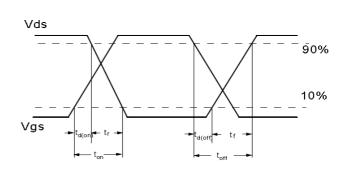
Gate Charge Test Circuit & Waveform



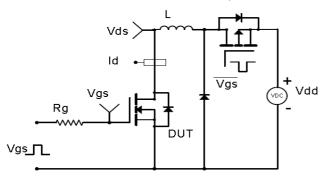


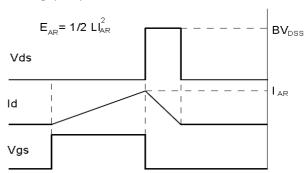
Resistive Switching Test Circuit & Waveforms



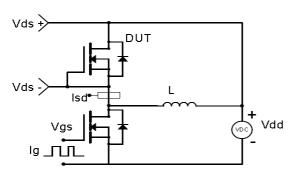


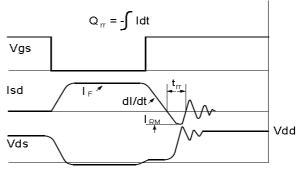
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





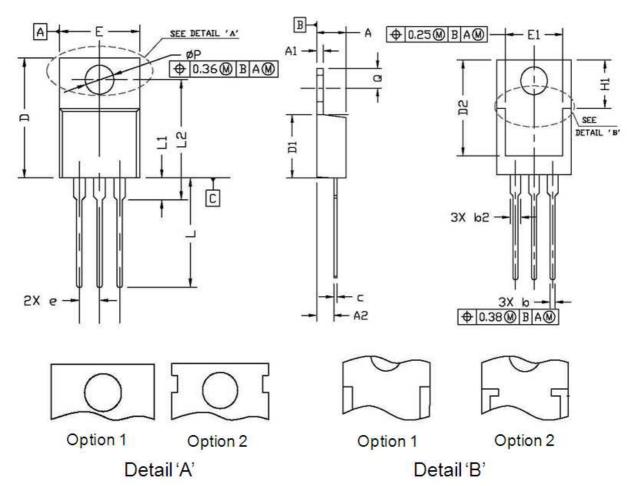
Diode Recovery Test Circuit & Waveforms







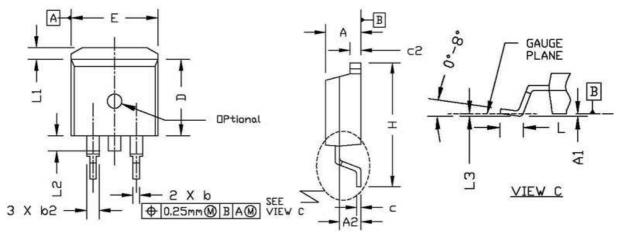
Package Outline: TO-220-3L

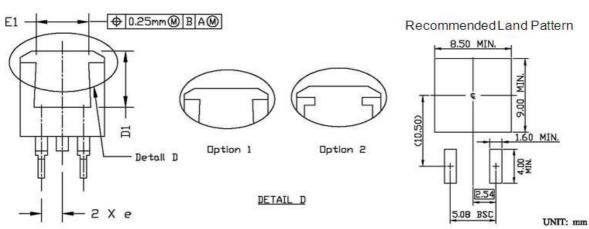


Compleal	Dimensions I	n Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.80	0.169	0.189
A1	1.20	1.45	0.047	0.057
A2	2.20	2.90	0.087	0.114
b	0.69	0.95	0.027	0.037
b2	1.00	1.60	0.039	0.063
С	0.33	0.65	0.013	0.026
D	14.70	16.20	0.579	0.638
D1	8.59	9.65	0.338	0.380
D2	11.75	13.60	0.463	0.535
е	2.54	BSC.	0.10	0 BSC.
E	9.60	10.60	0.378	0.417
E1	7.00	8.46	0.276	0.333
H1	6.20	7.00	0.244	0.276
L	12.60	14.80	0.496	0.583
L1	2.70	3.80	0.106	0.150
L2	12.13	16.50	0.478	0.650
Q	2.40	3.10	0.094	0.122
Р	3.50	3.90	0.138	0.154



Package Outline: TO-263





Symbol	Dimensions I	n Millimeters	Dimension	ns In Inches		
Symbol	Min.	Max.	Min.	Max.		
А	4.30	4.86	0.169	0.191		
A1	0.00	0.25	0.000	0.010		
A2	2.34	2.79	0.092	0.110		
b	0.68	0.94	0.027	0.037		
b2	1.15	1.35	0.045	0.053		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.38	9.45	0.330	0.372		
D1	6.90	8.17	0.272	0.322		
е	2.54	BSC.	0.100 BSC.			
E	9.78	10.50	0.385	0.413		
E1	6.50	8.60	0.256	0.339		
Н	14.61	15.88	0.575	0.625		
L	2.24	3.00	0.088	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
L3	0.00	0.25	0.000	0.010		





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Revision History

Revison	Date	Major changes
1.0	2018-11-02	Release of formal version.
1.1	2019-02-28	Revise Bug Idss Condition;
2.0	2019-05-28	Supplement package outline info&Zthjc Curve;
3.0	2020-02-20	Revise Crss Data; Add Dynamic Data Control;

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qulified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semicondutor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

